

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











300mW DUAL SURFACE MOUNT ZENER DIODE

Features

- Dual Zeners in Common Cathode Configuration
- 300 mW Power Dissipation
- Ideally Suited for Automated Insertion
- ΔV_Z For Both Diodes in One Case is $\leq 5\%$
- Common Anode Style Available, See AZ Series
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)
- Qualified to AEC-Q101 Standards for High Reliability

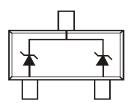
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 lead frame (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)

SOT23



Top View



Device Schematic

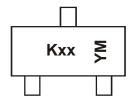
Ordering Information (Note 5)

Device	Qualification	Packaging	Shipping
(Type Number)-7-F*	Commercial	SOT23	3000/Tape & Reel
(Type Number)Q-7-F*	Automotive	SOT23	3000/Tape & Reel

^{*}Add "-7-F" to the appropriate type number in Electrical Characteristics Table on Page 2. Example: 6.2V Zener = DZ23C6V2-7-F.

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Product manufactured with Date Code OW (week 42, 2009) and newer are built with Green Molding Compound. Product manufactured prior to Date Code OW are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants. 5. For Packaging Details, go to our website at http://www.diodes.com/products/packages.html

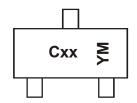
Marking Information



K = SAT (Shanghai Assembly / Test site) xx = Product Type Marking Code See Electrical Characteristics Table YM = Date Code Marking

Y = Year (ex: Z = 2012)

M = Month (ex: 9 = September)



C = CAT (Chengdu Assembly / Test site) xx = Product Type Marking Code See Electrical Characteristics Table YM = Date Code Marking

Y = Year (ex: Z = 2012)

M = Month (ex: 9 = September)

Date Code Key

Year '	1998		2002	2003	2004		2010	2011	2012	2013	2014	2015	2016	2017	2018
Code	J		Ν	Р	R		Х	Υ	Z	Α	В	С	D	Е	F
Month	Jan	Feb) (Mar	Apr	May	Jui	n	Jul	Aug	Sep	Oc	t N	lov	Dec
Code	1	2		3	4	5	6		7	8	9	0		N	D



Thermal Characteristics

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 6)	P_{D}	300	mW
Thermal Resistance, Junction to Ambient Air	(Note 6)	$R_{\theta JA}$	417	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-65 to +150	°C

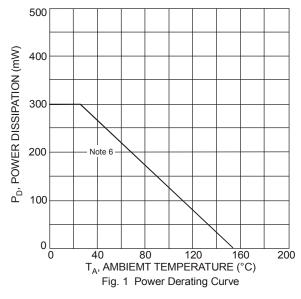
Notes: 6. Mounted on FR4 PC Board with recommended pad layout which can be found on our website at http://www.diodes.com.

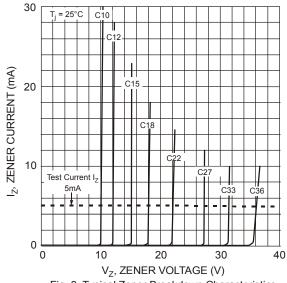
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Type Marking Number Code		Zener Voltage Range (Note 7)	Zener Im	mum ipedance IkHz	Typical Temperature Coefficient	Min. Reverse Voltage (Note 7)
Nulliber	Code	@ $I_{ZT} = 5.0 \text{mA}$ Z_{ZT} @ $I_{ZT} = 5.0 \text{mA}$ Z_{ZK} @ $I_{ZK} = 1.0 \text{mA}$		$Z_{ZK} @ I_{ZK} = 1.0 mA$	Coefficient	$@ I_R = 0.1 \mu A$
		V _Z (V)	Ω	Ω	TC (%/°C)	V _R (V)
DZ23C2V7	V1	2.5-2.9	83	500	-0.065	_
DZ23C3V0	V2	2.8-3.2	95	500	-0.060	_
DZ23C3V3	V3	3.1-3.5	95	500	-0.055	_
DZ23C3V6	V4	3.4-3.8	95	500	-0.055	_
DZ23C3V9	V5	3.7-4.1	95	500	-0.050	_
DZ23C4V3	V6	4.0-4.6	95	500	-0.035	_
DZ23C4V7	V7	4.4-5.0	78	500	-0.015	_
DZ23C5V1	V8	4.8-5.4	60	480	+0.005	0.8
DZ23C5V6	V9	5.2-6.0	40	400	+0.020	1.0
DZ23C6V2	VA	5.8-6.6	10	200	+0.030	2.0
DZ23C6V8	VB	6.4-7.2	8.0	150	+0.045	3.0
DZ23C7V5	VC	7.0-7.9	7.0	50	+0.050	5.0
DZ23C8V2	VD	7.7-8.7	7.0	50	+0.055	6.0
DZ23C9V1	VE	8.5-9.6	10	50	+0.065	7.0
DZ23C10	VF	9.4-10.6	15	70	+0.065	7.5
DZ23C11	VG	10.4-11.6	20	70	+0.070	8.5
DZ23C12	VH	11.4-12.7	20	90	+0.075	9.0
DZ23C13	VI	12.4-14.1	25	110	+0.080	10.0
DZ23C15	VJ	13.8-15.6	30	110	+0.080	11.0
DZ23C16	VK	15.3-17.1	40	170	+0.090	12.0
DZ23C18	VL	16.8-19.1	50	170	+0.090	14.0
DZ23C20	VM	18.8-21.2	50	220	+0.090	15.0
DZ23C22	VN	20.8-23.3	55	220	+0.090	17.0
DZ23C24	VO	22.8-25.6	80	220	+0.090	18.0
DZ23C27	VP	25.1-28.9	80	250	+0.090	20.0
DZ23C30	VQ	28-32	80	250	+0.090	22.5
DZ23C33	VR	31-35	80	250	+0.090	25.0
DZ23C36	VS	34-38	90	250	+0.090	27.0
DZ23C39	VT	37-41	90	300	+0.110	29.0
DZ23C43	VU	40-46	100	700	+0.110	32.0
DZ23C47	VV	44-50	100	750	+0.110	35.0
DZ23C51	VW	48-54	100	750	+0.110	38.0

Notes: 7. Short duration pulse test used to minimize self-heating effect.







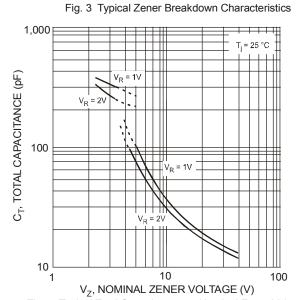


Fig. 5 Typical Total Capacitance vs. Nominal Zener Voltage

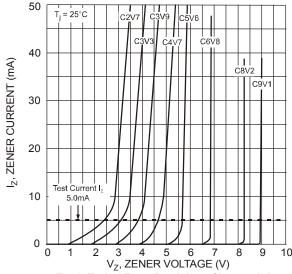


Fig. 2 Typical Zener Breakdown Characteristics

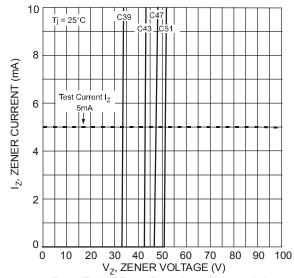
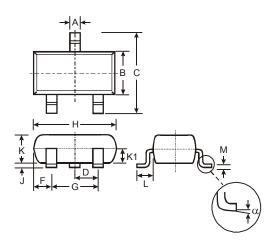


Fig. 4 Typical Zener Breakdown Characteristics



Package Outline Dimensions

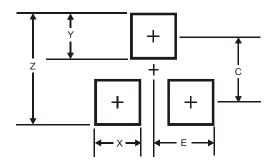
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.903	1.10	1.00				
K1	_	_	0.400				
L	0.45	0.61	0.55				
М	0.085	0.18	0.11				
α	0°	8°	_				
All	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
Е	1.35



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2012, Diodes Incorporated

www.diodes.com